

75Ω

50 to 1000 MHz

Maximum Ratings

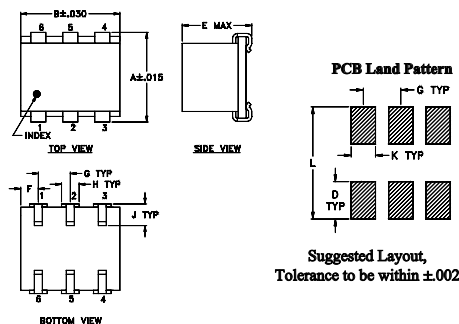
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25W
DC Current	30mA

Permanent damage may occur if any of these limits are exceeded.

Pin Connections

PRIMARY DOT	3
PRIMARY	1
SECONDARY DOT	6
SECONDARY	4
SECONDARY CT	5
NOT USED	2

Outline Drawing



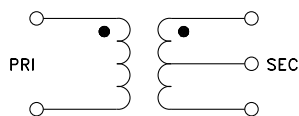
Outline Dimensions (inch)

A	B	C	D	E	F	G
.280	.310	--	.100	.225	.055	.100
7.11	7.87	--	2.54	5.72	1.40	2.54

H	J	K	L	wt
.047	.065	.065	.300	grams
1.19	1.65	1.65	7.62	0.45

Demo Board MCL P/N: TB-169

Config. A



Features

- excellent return loss, 26 dB typ. in 1 dB bandwidth
- excellent amplitude unbalance, 0.4 dB typ. and phase unbalance, 3 deg. typ. in 1 dB bandwidth
- excellent insertion loss flatness, ±0.25 dB

Applications

- impedance matching
- balanced amplifiers



Generic photo used for illustration purposes only

CASE STYLE: BH292

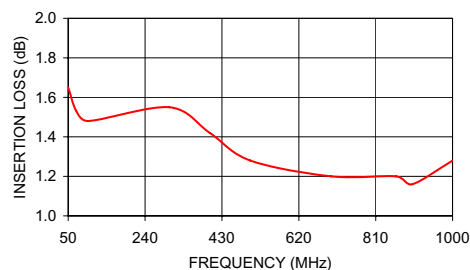
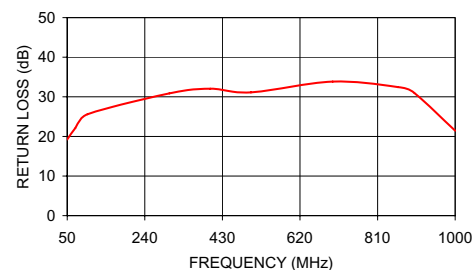
Transformer Electrical Specifications

Ω RATIO (Secondary/Primary)	FREQUENCY (MHz)	INSERTION LOSS*			PHASE UNBALANCE (Deg.) Typ.		AMPLITUDE UNBALANCE (dB) Typ.	
		3 dB MHz	2 dB MHz	1 dB MHz	1 dB bandwidth	2 dB bandwidth	1 dB bandwidth	2 dB bandwidth
2	50-1000	—	—	50-1000	3	—	0.4	—

* Insertion Loss is referenced to mid-band loss, 1.5 dB typ.

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
50.00	1.65	19.25	0.03	0.18
70.00	1.53	22.13	0.06	0.29
100.00	1.48	25.62	0.10	0.66
300.00	1.55	30.86	0.02	2.40
400.00	1.42	32.04	0.10	2.27
500.00	1.28	31.12	0.23	2.01
700.00	1.20	33.85	0.37	0.66
860.00	1.20	32.46	0.36	0.87
900.00	1.16	30.98	0.34	1.40
1000.00	1.28	21.44	0.19	2.47

JTX-2-10T
INSERTION LOSSJTX-2-10T
INPUT RETURN LOSS

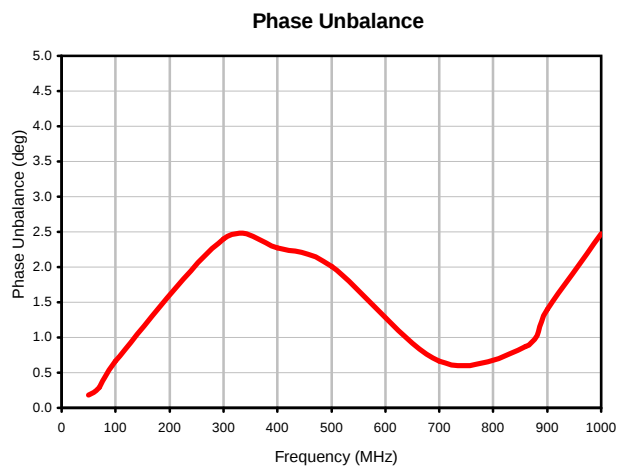
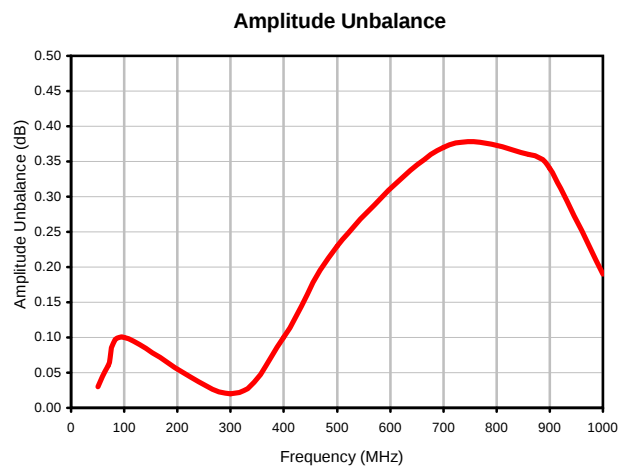
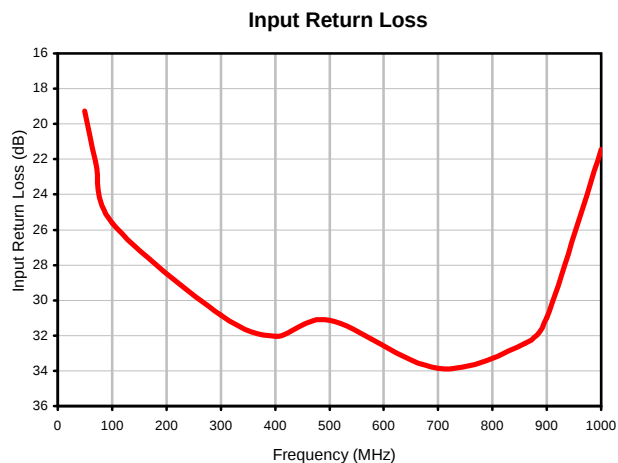
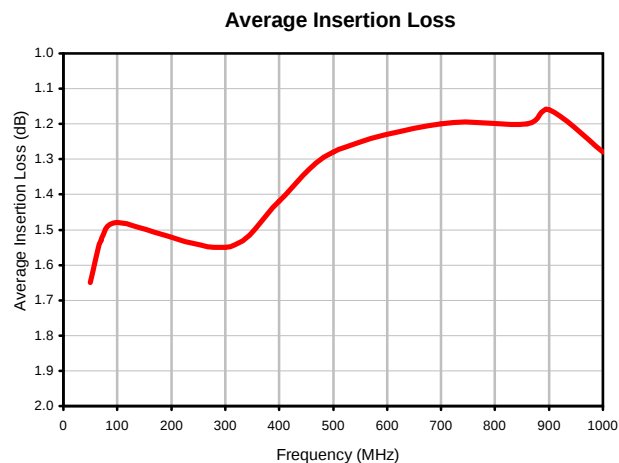
Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

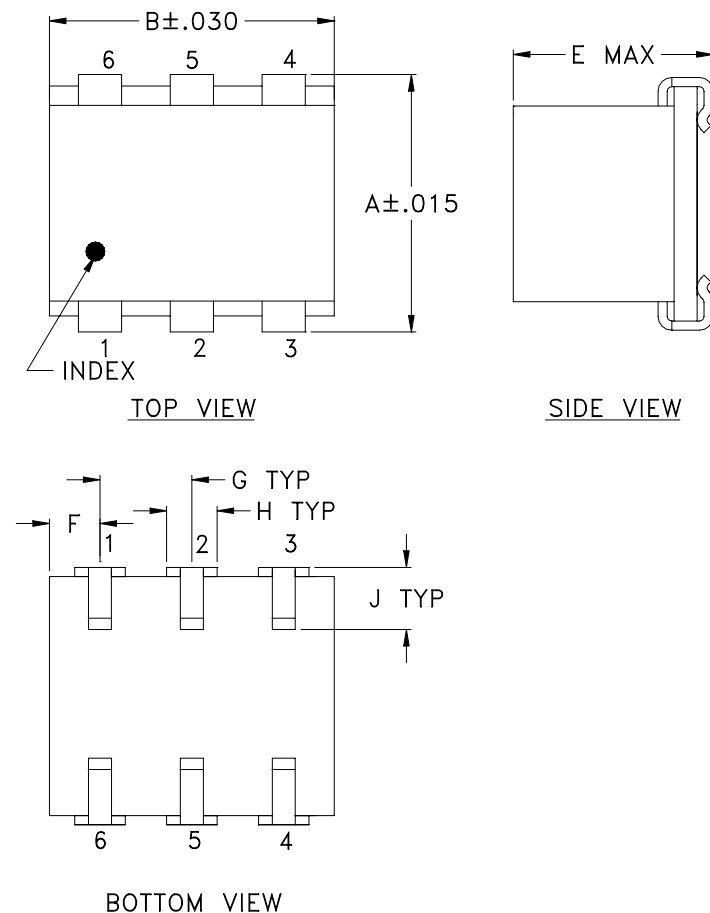
Typical Performance Data

FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg)
50	1.65	19.25	0.03	0.18
70	1.53	22.13	0.06	0.29
100	1.48	25.62	0.10	0.66
300	1.55	30.86	0.02	2.40
400	1.42	32.04	0.10	2.27
500	1.28	31.12	0.23	2.01
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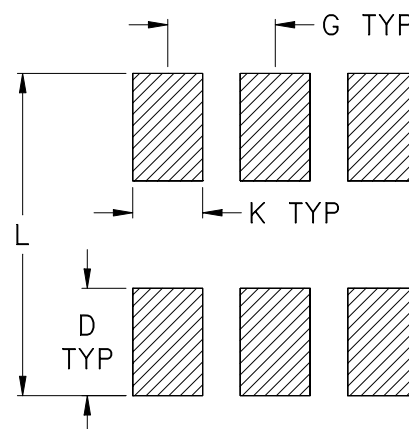
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

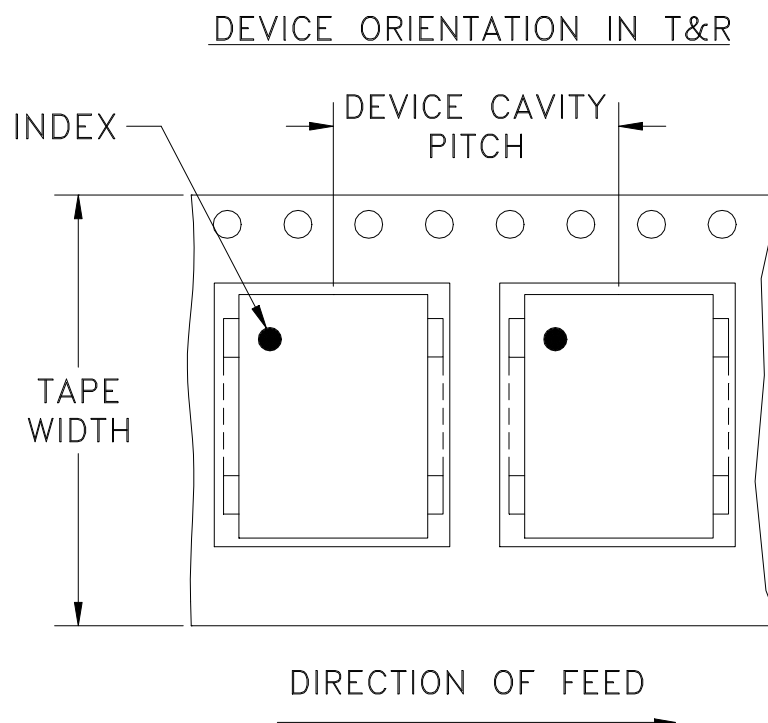
CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAM
BH292	.280 (7.11)	.310 (7.87)	- -	.100 (2.54)	.225 (5.72)	.055 (1.40)	.100 (2.54)	.047 (1.19)	.065 (1.65)	.065 (1.65)	.300 (7.62)	.45

Dimensions are in inches (mm). Tolerances: 2Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Ceramic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

Tape & Reel Packaging TR-F24



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel
16	12	13	500

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



INTERNET <http://www.minicircuits.com>

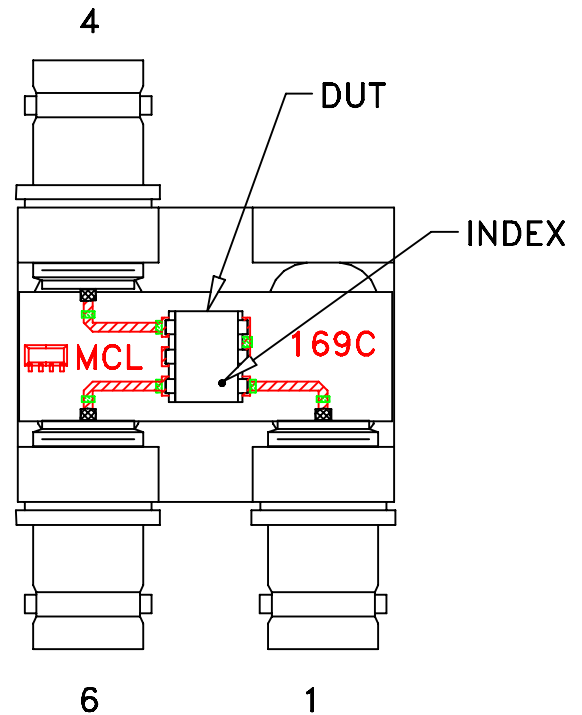
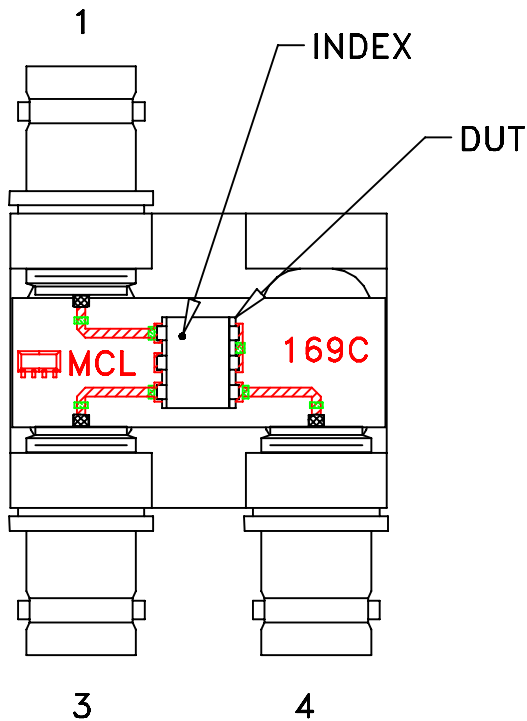
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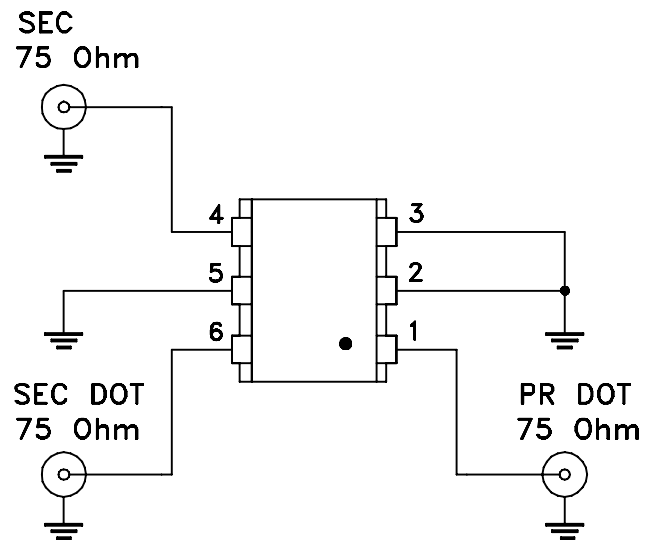
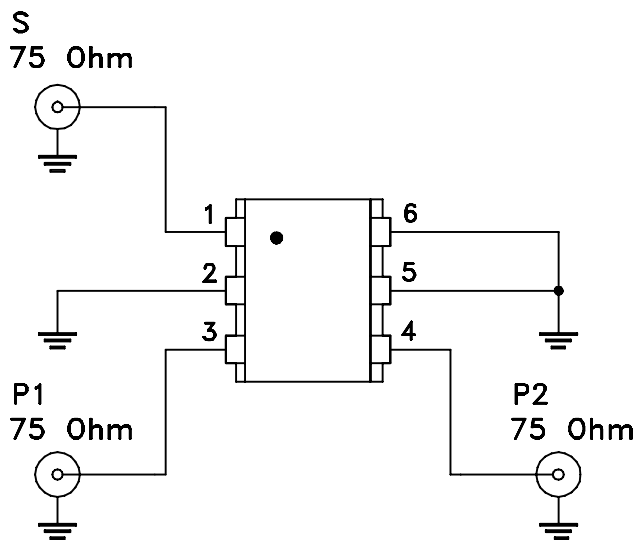
Mini-Circuits ISO 9001 & ISO 14001 Certified

Evaluation Board and Circuit

For Pin Connections and DUT Orientation Refer to
Data Sheet of the DUT



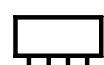
TB-169



Schematic Diagram

Notes:

1. BNC Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.030 inch.

 Mini-Circuits®



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215